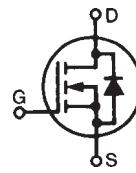


# Polar™ Power MOSFET

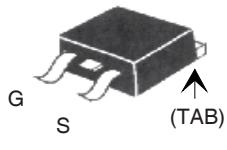
N-Channel Enhancement Mode  
Avalanche Rated

**IXTA1N80P**  
**IXTP1N80P**  
**IXTU1N80P**  
**IXTY1N80P**

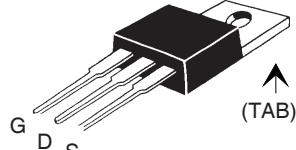


**V<sub>DSS</sub>** = 800V  
**I<sub>D25</sub>** = 1A  
**R<sub>DS(on)</sub>** ≤ 14Ω

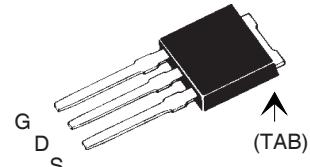
TO-263 (IXTA)



TO-220 (IXTP)



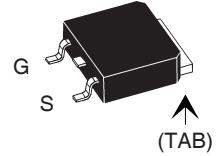
TO-251 (IXTU)



Symbol	Test Conditions	Maximum Ratings		
<b>V<sub>DSS</sub></b>	T <sub>J</sub> = 25°C to 150°C	800		V
<b>V<sub>DGR</sub></b>	T <sub>J</sub> = 25°C to 150°C, R <sub>GS</sub> = 1MΩ	800		V
<b>V<sub>GSS</sub></b>	Continuous	±20		V
<b>V<sub>GSM</sub></b>	Transient	±30		V
<b>I<sub>D25</sub></b>	T <sub>C</sub> = 25°C	1		A
<b>I<sub>DM</sub></b>	T <sub>C</sub> = 25°C, Pulse Width Limited by T <sub>JM</sub>	2		A
<b>I<sub>A</sub></b>	T <sub>C</sub> = 25°C	1		A
<b>E<sub>AS</sub></b>	T <sub>C</sub> = 25°C	75		mJ
<b>dV/dt</b>	I <sub>S</sub> ≤ I <sub>DM</sub> , V <sub>DD</sub> ≤ V <sub>DSS</sub> , T <sub>J</sub> ≤ 150°C	5		V/ns
<b>P<sub>D</sub></b>	T <sub>C</sub> = 25°C	42		W
<b>T<sub>J</sub></b>		-55 ... +150		°C
<b>T<sub>JM</sub></b>		150		°C
<b>T<sub>stg</sub></b>		-55 ... +150		°C
<b>T<sub>L</sub></b>	1.6mm (0.062) from Case for 10s	300		°C
<b>T<sub>SOLD</sub></b>	Plastic Body for 10s	260		°C
<b>M<sub>d</sub></b>	Mounting Torque (TO-220)	1.13 / 10		Nm/lb.in.
<b>Weight</b>	TO-263	2.50		g
	TO-220	3.00		g
	TO-252	0.35		g
	TO-251	0.40		g

Symbol	Test Conditions (T <sub>J</sub> = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
<b>BV<sub>DSS</sub></b>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	800		V
<b>V<sub>GS(th)</sub></b>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 50μA	2.0		4.0 V
<b>I<sub>GSS</sub></b>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±100 nA
<b>I<sub>DSS</sub></b>	V <sub>DS</sub> = V <sub>DSS</sub> V <sub>GS</sub> = 0V			3 μA 30 μA
<b>R<sub>DS(on)</sub></b>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.5 • I <sub>D25</sub> , Note 1	10	14	Ω

TO-252 (IXTY)



G = Gate      D = Drain  
S = Source      TAB = Drain

## Features

- International Standard Packages
- Fast Intrinsic Rectifier
- Avalanche Rated
- Low Package Inductance

## Advantages

- Easy to Mount
- Space Savings
- High Power Density

## Applications

- Switched-Mode and Resonant-Mode Power Supplies
- DC-DC Converters
- Laser Drivers
- AC and DC Motor Drives
- Robotics and Servo Controls



IXTA1N80P IXTP1N80P  
IXTU1N80P IXTY1N80P

Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$g_{fs}$	$V_{DS} = 20\text{V}$ , $I_D = 0.5 \cdot I_{D25}$ , Note 1	0.30	0.55	S
$C_{iss}$ $C_{oss}$ $C_{rss}$	$V_{GS} = 0\text{V}$ , $V_{DS} = 25\text{V}$ , $f = 1\text{MHz}$	250 22 5.3		pF pF pF
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	<b>Resistive Switching Times</b> $V_{GS} = 10\text{V}$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_D = 0.5 \cdot I_{D25}$ $R_G = 50\Omega$ (External)	20 18 58 42		ns ns ns ns
$Q_{g(on)}$ $Q_{gs}$ $Q_{gd}$	$V_{GS} = 10\text{V}$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_D = 0.5 \cdot I_{D25}$	9.0 1.4 5.5		nC nC nC
$R_{thJC}$ $R_{thCS}$	(TO-220)	0.50	3.0	$^\circ\text{C}/\text{W}$ $^\circ\text{C}/\text{W}$

#### Source-Drain Diode

#### Characteristic Values

( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified)

Symbol	Test Conditions	Min.	Typ.	Max.
$I_s$	$V_{GS} = 0\text{V}$		1	A
$I_{SM}$	Repetitive, Pulse Width Limited by $T_{JM}$		4	A
$V_{SD}$	$I_F = I_S$ , $V_{GS} = 0\text{V}$ , Note 1		1.3	V
$t_{rr}$	$I_F = 1\text{A}$ , $-di/dt = 100\text{A}/\mu\text{s}$ $V_R = 100\text{V}$ , $V_{GS} = 0\text{V}$	700		ns

Note 1: Pulse Test,  $t \leq 300\mu\text{s}$ ; Duty Cycle,  $d \leq 2\%$ .

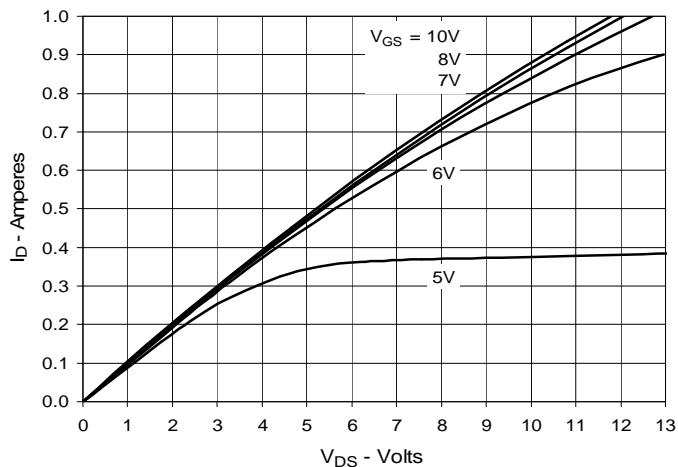
#### PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

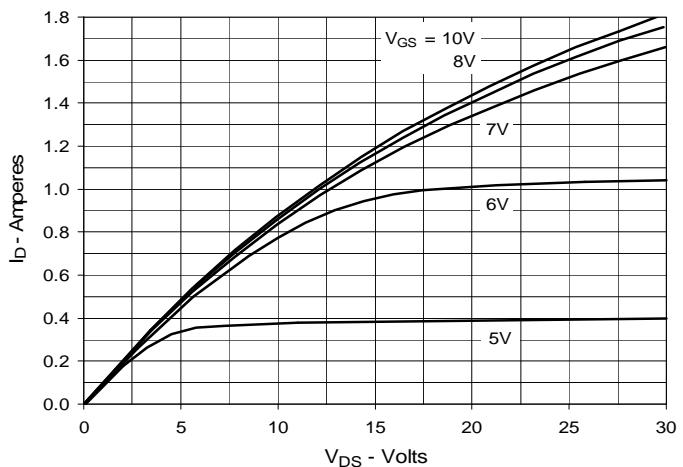
IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

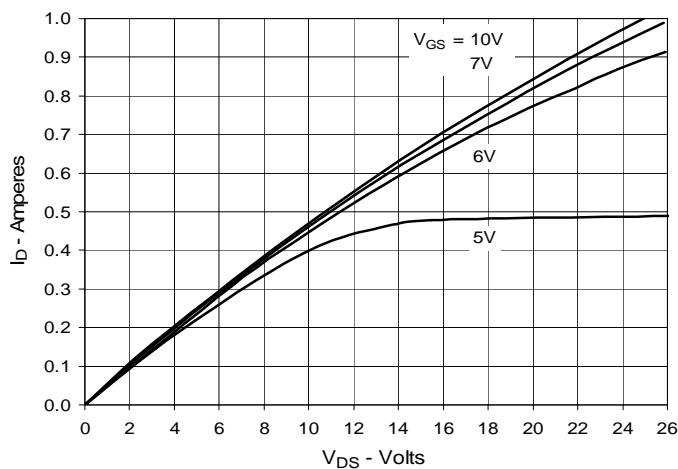
**Fig. 1. Output Characteristics  
@ 25°C**



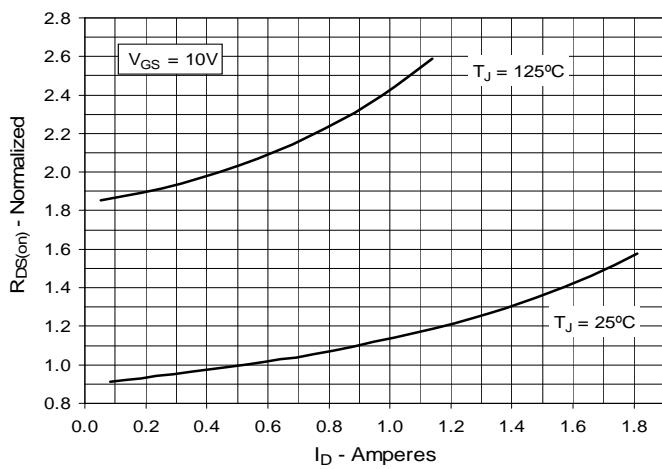
**Fig. 2. Extended Output Characteristics  
@ 25°C**



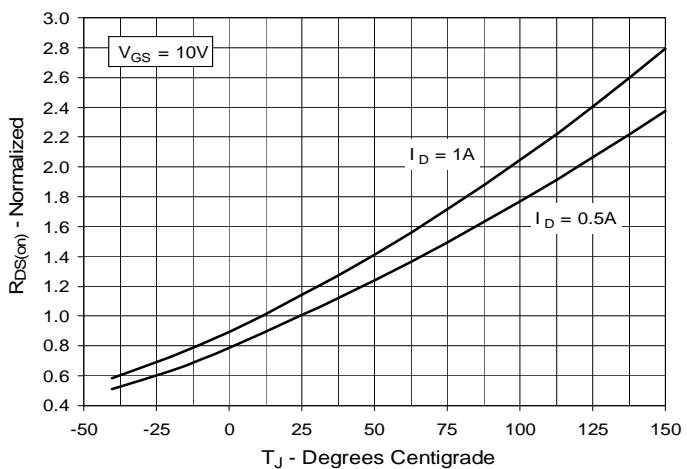
**Fig. 3. Output Characteristics  
@ 125°C**



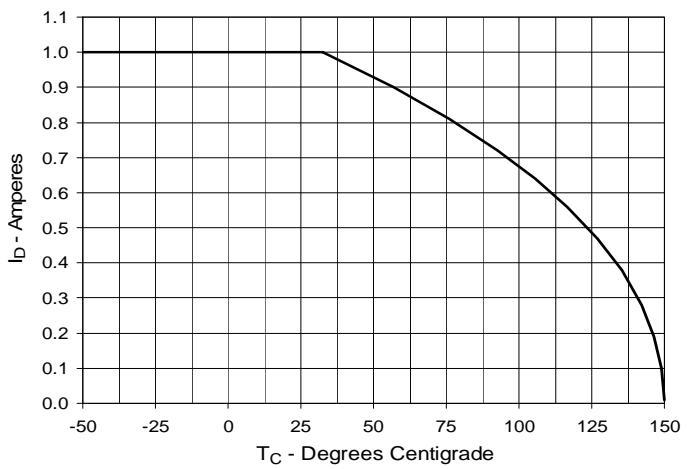
**Fig. 5.  $R_{DS(on)}$  Normalized to  $I_D = 0.5A$  Value  
vs. Drain Current**

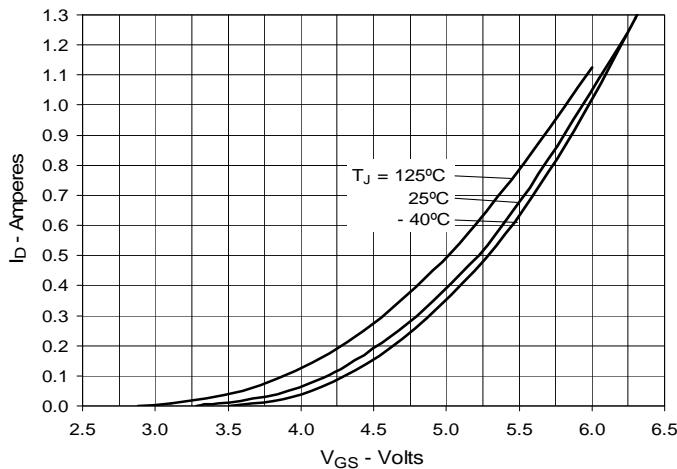
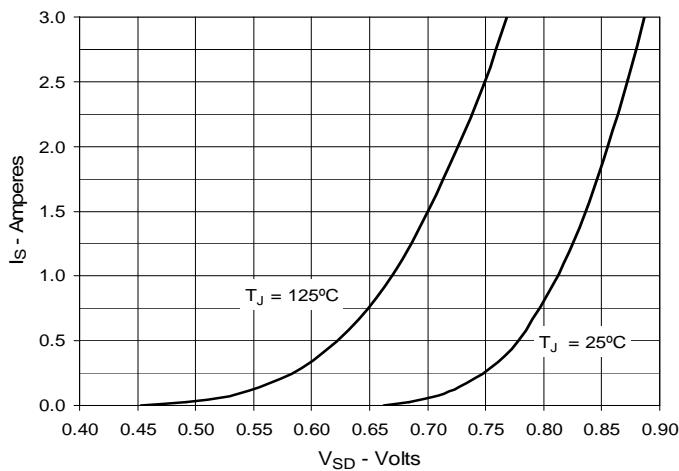
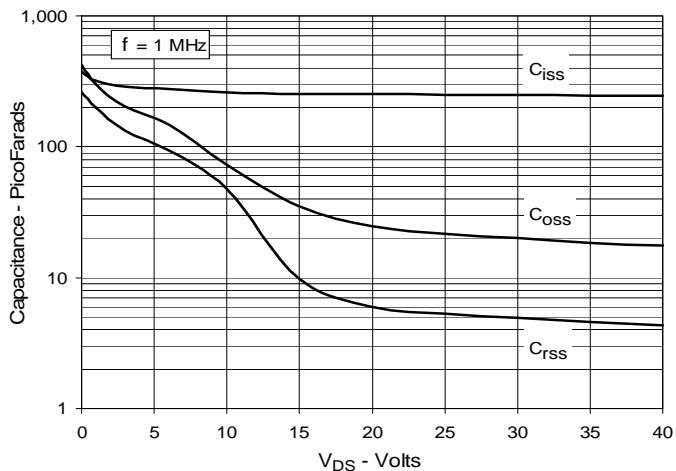
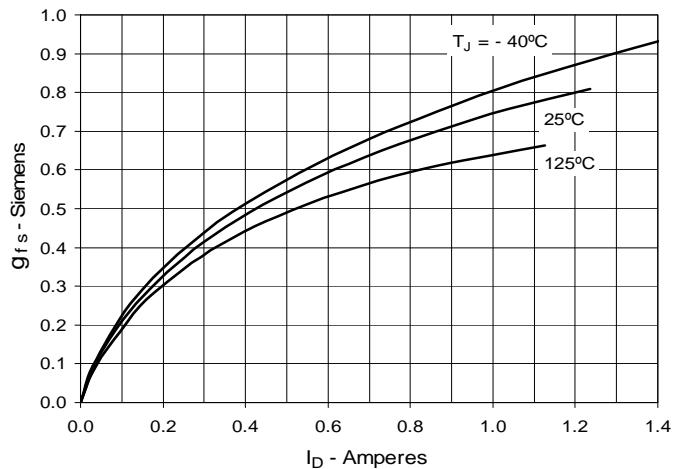
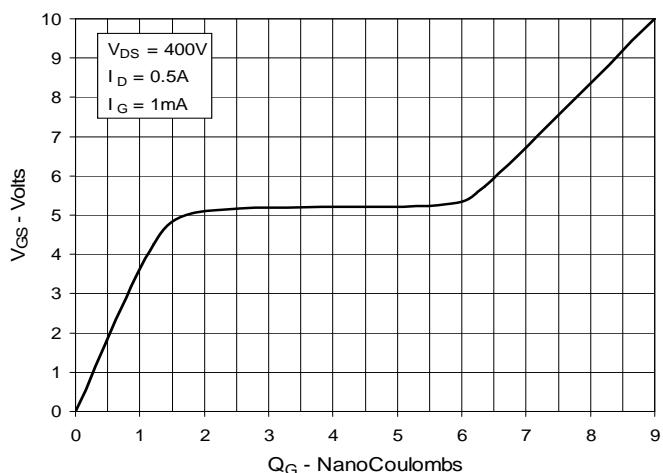
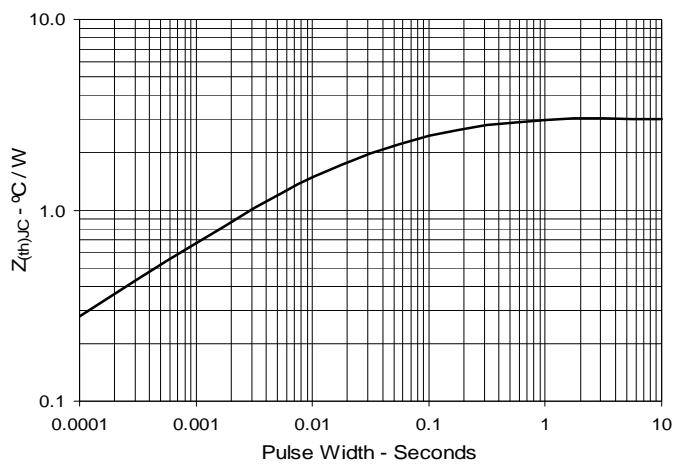


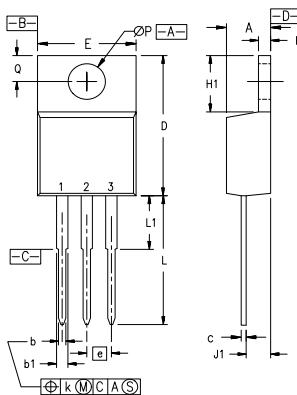
**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = 0.5A$  Value  
vs. Junction Temperature**



**Fig. 6. Maximum Drain Current vs.  
Case Temperature**

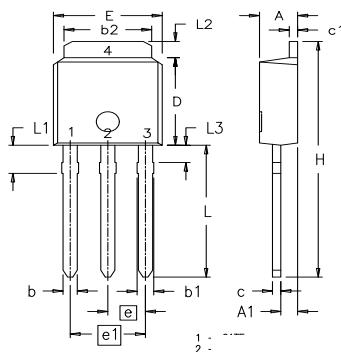


**Fig. 7. Input Admittance**

**Fig. 9. Forward Voltage Drop of Intrinsic Diode**

**Fig. 11. Capacitance**

**Fig. 8. Transconductance**

**Fig. 10. Gate Charge**

**Fig. 12. Maximum Transient Thermal Impedance**


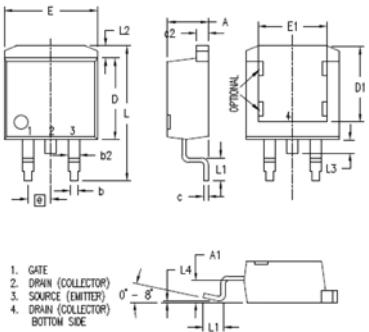
**TO-220 (IXTP) Outline**


Pins: 1 - Gate      2 - Drain

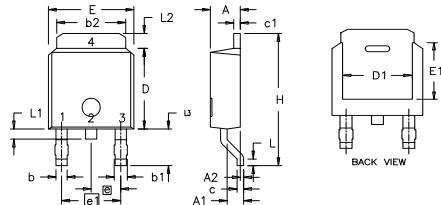
SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.170	.190	4.32	4.83
b	.025	.040	0.64	1.02
b1	.045	.065	1.15	1.65
c	.014	.022	0.35	0.56
D	.580	.630	14.73	16.00
E	.390	.420	9.91	10.66
e	.100	BSC	2.54	BSC
F	.045	.055	1.14	1.40
H1	.230	.270	5.85	6.85
J1	.090	.110	2.29	2.79
k	0	.015	0	0.38
L	.500	.550	12.70	13.97
L1	.110	.230	2.79	5.84
ØP	.139	.161	3.53	4.08
Q	.100	.125	2.54	3.18

**TO-251 (IXTU) Outline**

 1. Gate      2. Drain  
 3. Source      4. Drain

Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	2.19	2.38	.086	.094
A1	0.89	1.14	0.35	0.45
b	0.64	0.89	0.25	0.35
b1	0.76	1.14	0.30	0.45
b2	5.21	5.46	.205	.215
c	0.46	0.58	.018	.023
c1	0.46	0.58	.018	.023
D	5.97	6.22	.235	.245
E	6.35	6.73	.250	.265
e	2.28	BSC	.090	BSC
e1	4.57	BSC	.180	BSC
H	17.02	17.78	.670	.700
L	8.89	9.65	.350	.380
L1	1.91	2.28	.075	.090
L2	0.89	1.27	.035	.050

**TO-263 (IXTA) Outline**

 1. GATE  
 2. DRAIN (COLLECTOR)  
 3. SOURCE (EMITTER)  
 4. DRAIN (COLLECTOR)  
 BOTTOM SIDE

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.360	.390	4.06	4.83
A1	.080	.110	2.03	2.79
b	.020	.039	0.51	0.99
b2	.045	.055	1.14	1.40
c	.016	.029	0.40	0.74
c2	.045	.055	1.14	1.40
D	.340	.380	8.64	9.65
D1	.315	.350	8.00	8.89
E	.380	.410	9.65	10.41
E1	.245	.320	6.22	8.13
e	.100	BSC	2.54	BSC
L	.575	.625	14.61	15.88
L1	.090	.110	2.29	2.79
L2	.040	.055	1.02	1.40
L3	.050	.070	1.27	1.78
L4	0	.005	0	0.13

**TO-252 (IXTY) Outline**

 Pins: 1 - Gate  
 2,4 - Drain  
 3 - Source

Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	2.19	2.38	.086	.094
A1	0.89	1.14	0.35	0.45
A2	0	0.13	0	0.005
b	0.64	0.89	0.25	0.35
b1	0.76	1.14	0.30	0.45
b2	5.21	5.46	.205	.215
c	0.46	0.58	.018	.023
c1	0.46	0.58	.018	.023
D	5.97	6.22	.235	.245
D1	4.32	5.21	.170	.205
E	6.35	6.73	.250	.265
E1	4.32	5.21	.170	.205
L	9.40	10.42	.370	.410
L1	0.51	1.02	.020	.040
L2	0.64	1.02	.025	.040
L3	0.89	1.27	.035	.050
L4	2.54	2.92	.100	.115